

TPS24740EVM-596 Evaluation Module

1 Introduction

The TPS24740EVM-596 evaluation module (EVM) is a fully assembled and tested circuit for evaluating the TPS24740 high performance hot-swap and ORing controller. The EVM contains header connectors for easy connection to external test and application circuitry. See the TPS24740 data sheet for a list of device features and applications.

The TPS24740EVM-596 PCB is capable of accommodating the TPS24772 IC for hot-swap only evaluation and performance. This is described in Section 8 of this User's Guide.

1.1 Electrical Specifications

[Table 1](#) lists the TPS24740EVM-596 specifications.

Table 1. TPS24740EVM-596 Electrical and Performance Specifications at 25°C

PARAMETER	VALUE
Input voltage Range (operating)	11 to 13 V
Current operating	30 A
Power limit (nominal)	39 W
Current-limit (nominal)	35 A
Fault timer (nominal)	5.6 ms
UVLO rising (nominal)	10 V
UVLO falling (nominal)	9.6 V
Overvoltage rising (nominal)	14 V
Overvoltage falling (nominal)	13.5 V
Pass <i>hot-Short</i> on output	Yes
Pass <i>start into short</i> ?	Yes
Reverse current threshold	1.5 A
Reverse current filtering	0.5 μ s

2 Description

The TPS24740EVM-596 is designed to accommodate two OR and hotswap configurations (as shown in [Figure 1](#)) mainly to evaluate systems with multiple supplies and loads. The ORing after each supply ensures that the loads do not lose power when any of the supplies fail. The hotswap in front of each load ensures that a failure on one load does not affect the operation of other loads. The node on the output of the ORing and the input of the hot swaps is referred to as VMIDDLE.

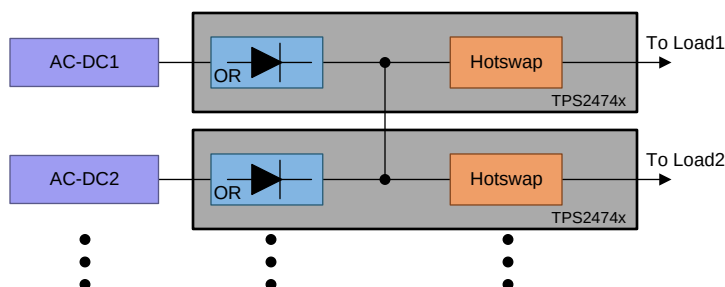


Figure 1. Block Diagram for Systems With Multiple Supplies and Loads

2.1 Jumpers

Table 2 lists the jumpers for the TPS24740EVM-596

Table 2. Jumpers (A and B Circuits)

JUMPER	DESCRIPTION
J1	Shorting J1 allows the same timing for the TINR and TFLT pins
J2	Shorting J2 disables ORing in the TPS24740
J3	Shorting J3 disables overvoltage
J4	Shorting J4 allows setting the voltage (through resistor) to enable the hot swap
J5	Shorting pins 2 and 3 pulls the flag pullup voltage to VMIDDLE Shorting pin 2 and 1 pulls the flag pullup voltage to VMIDDLE
J6	Shorting pins 2 and 3 pulls EN pullup voltage to VIN Shorting pin 2 and 1 pulls EN pullup voltage to an external bias voltage

2.2 Test Points

All test points are labeled appropriately on the TPS24740EVM-596 PCB according to the schematic in Figure 2.

3 Schematic

Figure 2 through Figure 4 illustrate the EVM schematics.

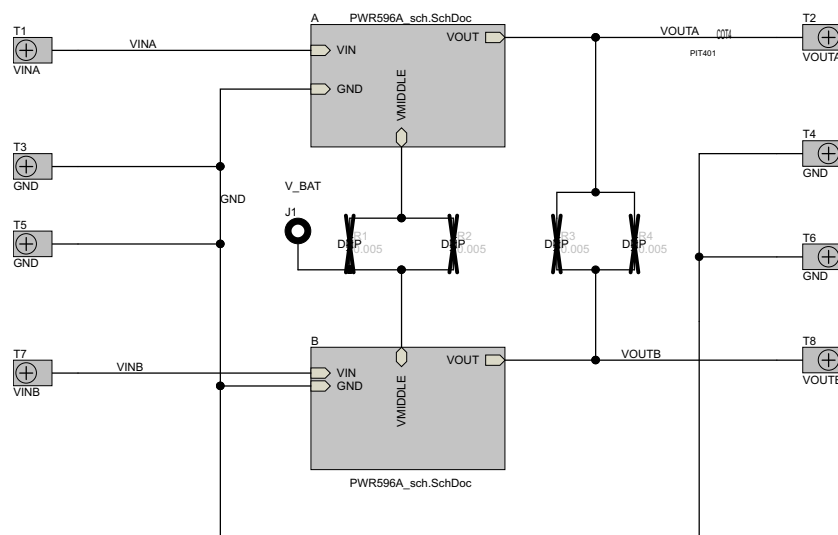


Figure 2. TPS24740EVM-596 High Level Schematic

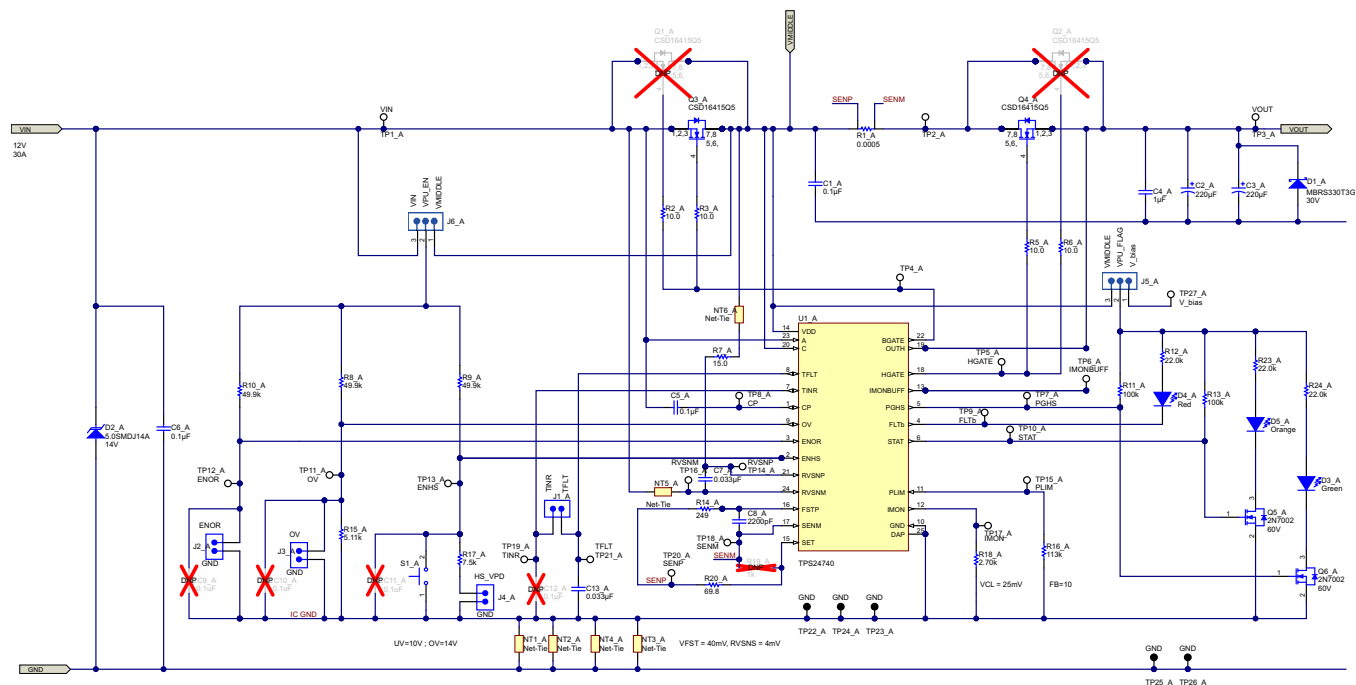


Figure 3. TPS24740EVM-596 OR Then Hotswap Schematic A

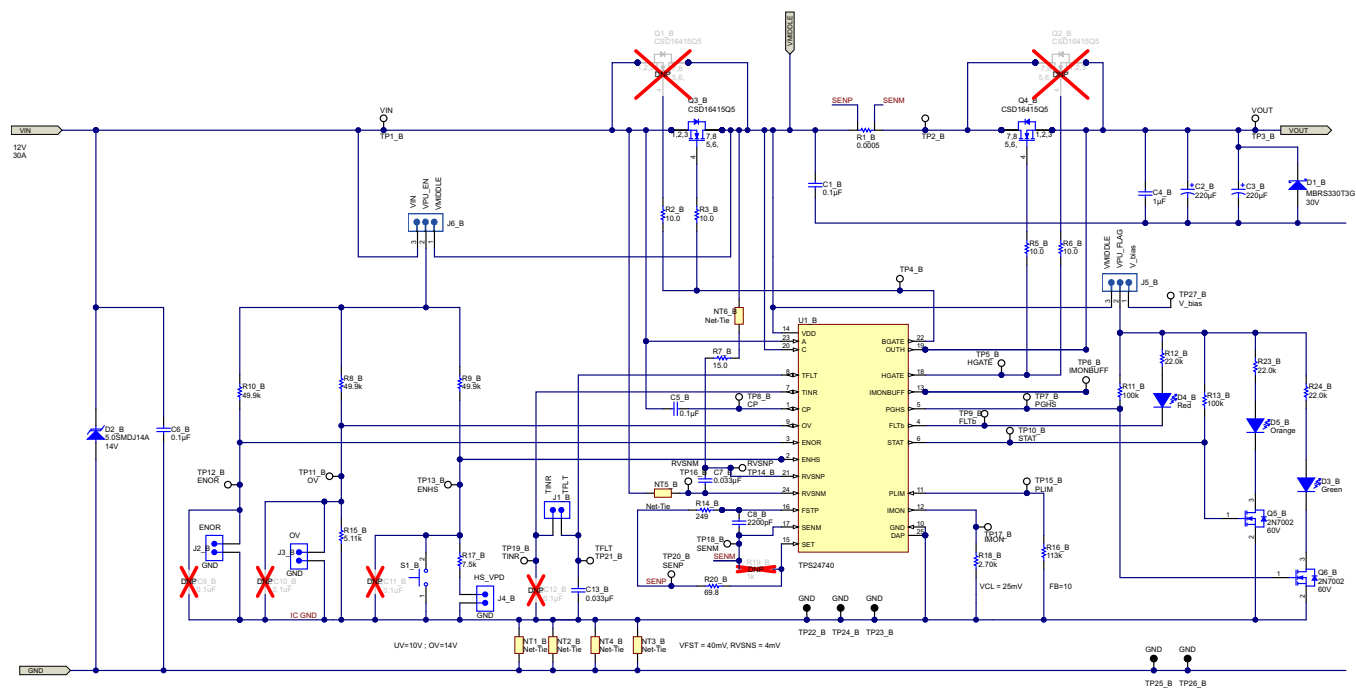


Figure 4. TPS24740EVM-596 OR Then Hotswap Schematic B

4 TPS24740 OR and Hot Swap Performance

Figure 5 through Figure 15 illustrate TPS24740 OR and hot swap performance.

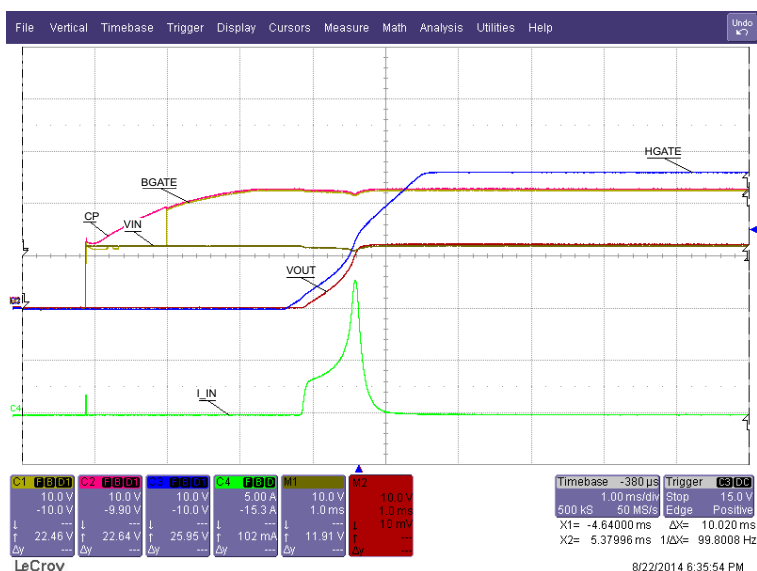


Figure 5. Startup ($C_O = 440 \mu\text{F}$)

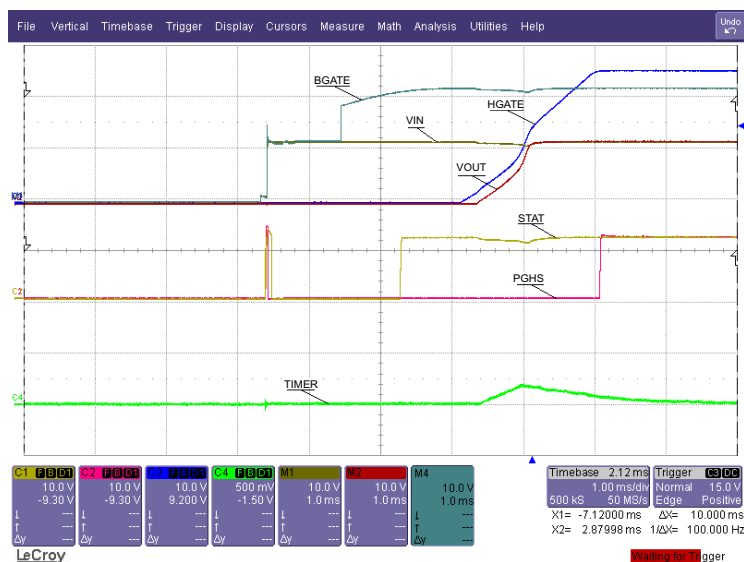


Figure 6. Startup ($C_O = 440 \mu\text{F}$)

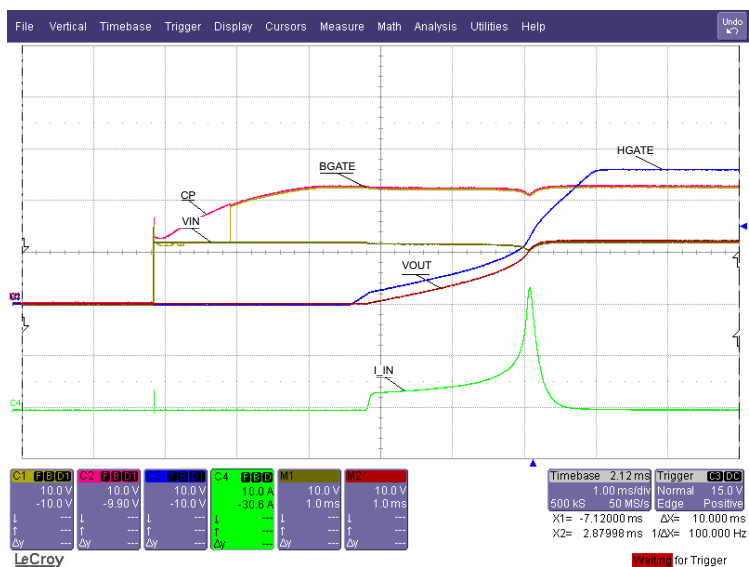


Figure 7. Startup ($C_O = 440 \mu F$)

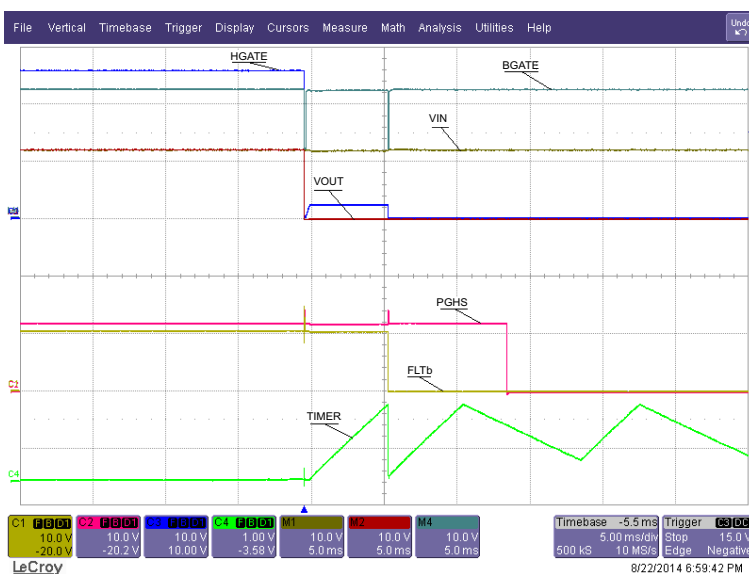


Figure 8. Hot Short on VOUT (Zoomed Out)

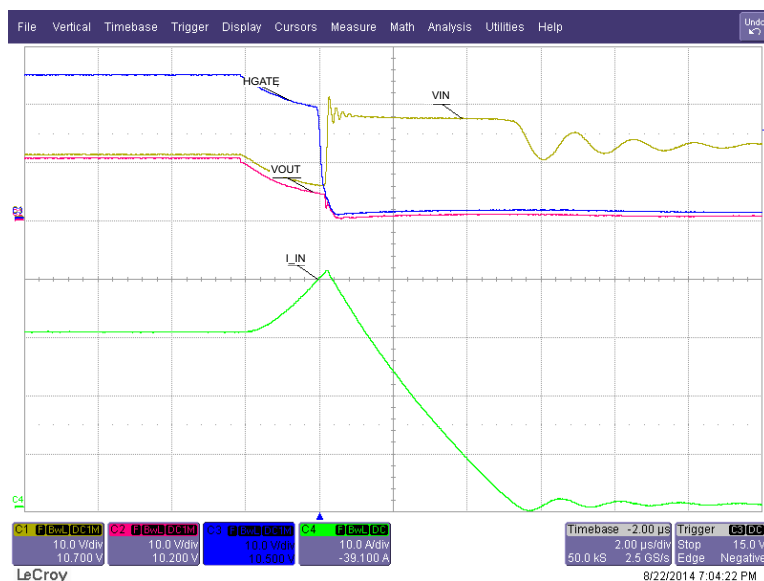


Figure 9. Hot Short on VOUT (Zoomed In)

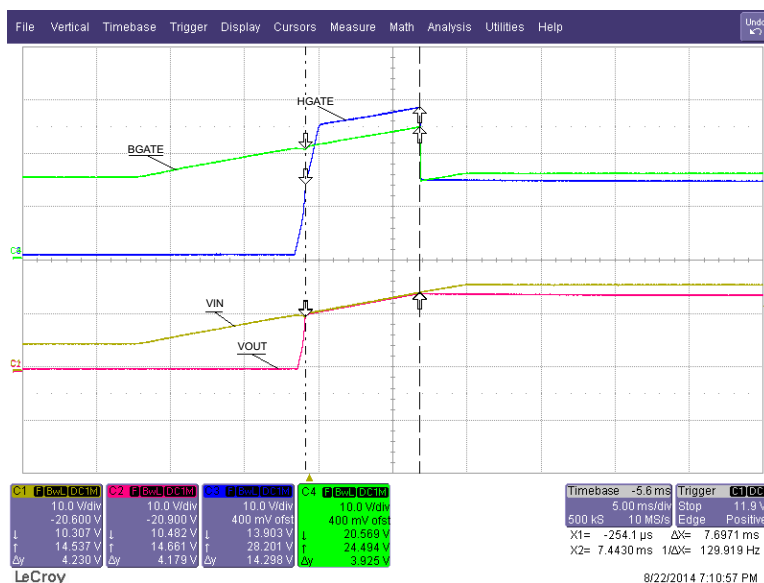


Figure 10. Undervoltage and Overvoltage With VIN Rising

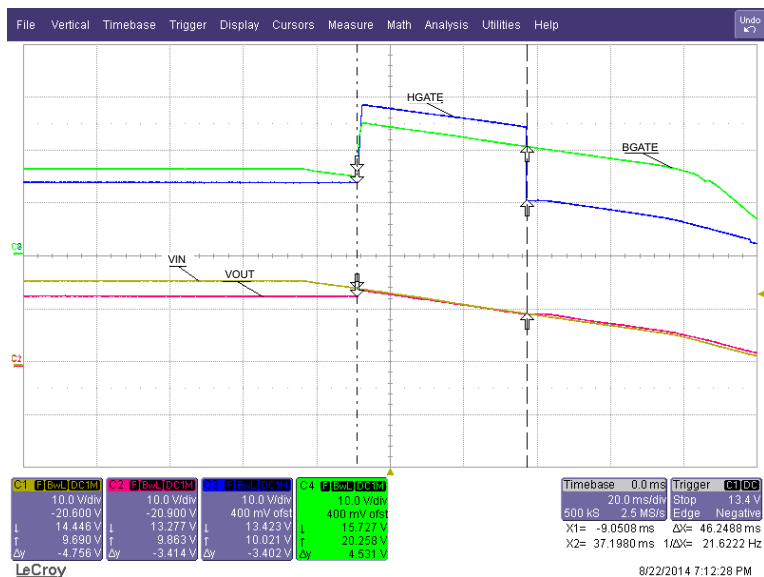


Figure 11. Undervoltage and Overvoltage With VIN Falling

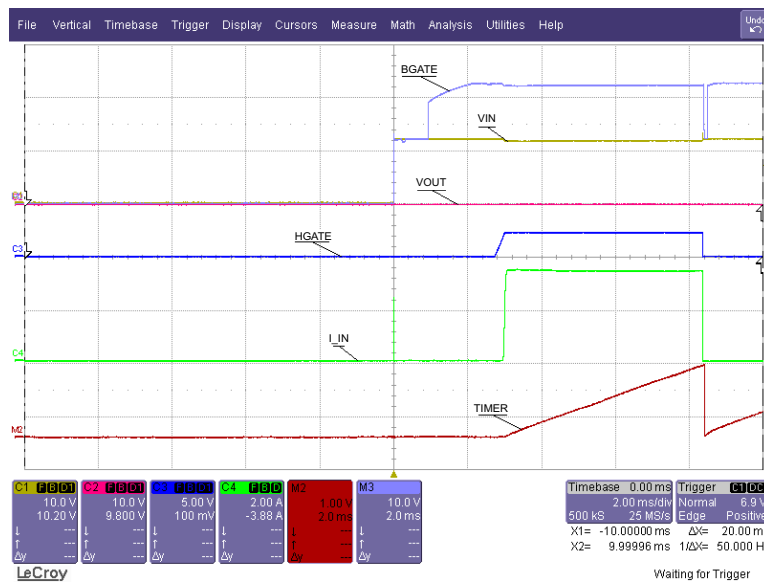


Figure 12. Start Into Short on VOUT

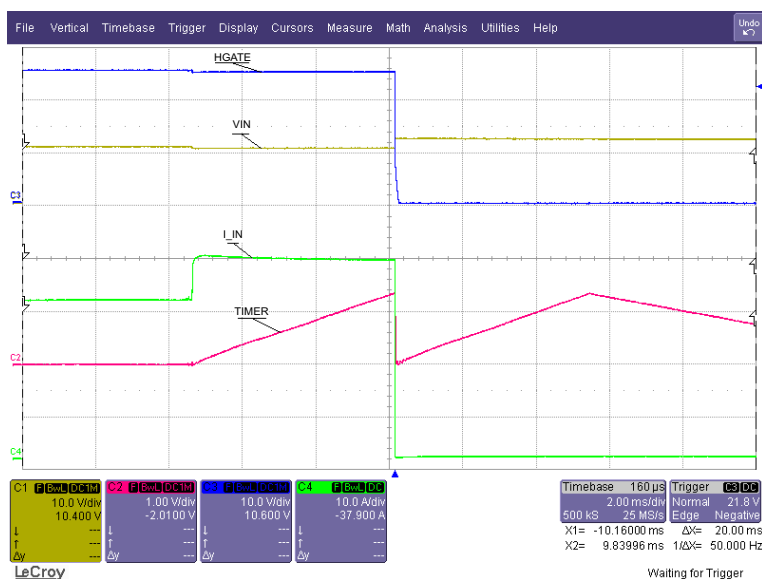


Figure 13. Load Step, 32 A to 40 A

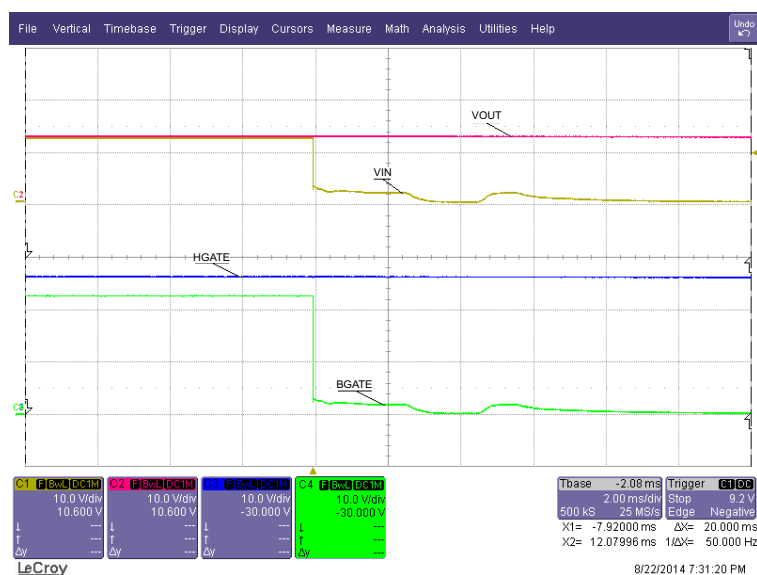


Figure 14. Hot Short on VIN

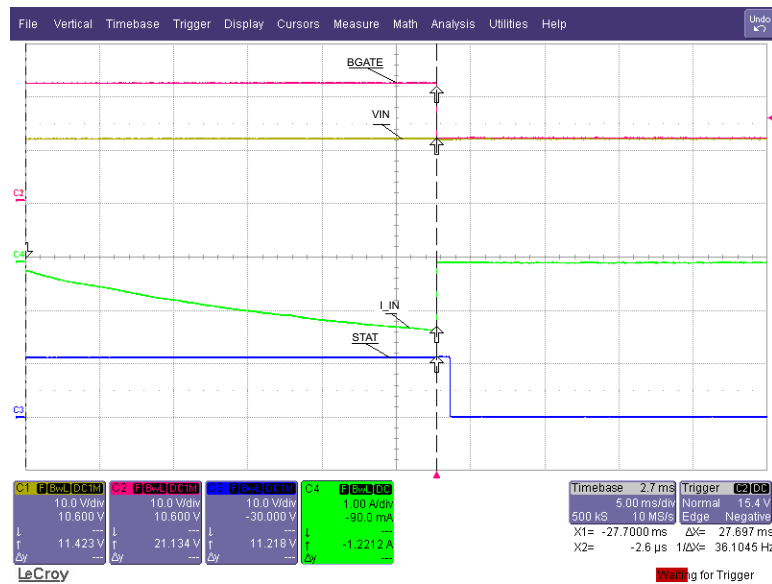


Figure 15. Gradual Reverse Current

5 Multi-Supply and Multi-Load Performance

The TPS24740EVM-596 as is can be evaluated to test an individual OR then hot swap circuit (Figure 3 or Figure 4). The following results show the performance for multiple supplies and loads as shown in Figure 1.

5.1 EVM Setup

To set up the EVM, use the following steps:

- Step 1. Short R1 and R2 to connect VMIDDLE. See Figure 2.
- Step 2. Place jumpers between J4 and J1 (both A and B circuits)
- Step 3. Select VMIDDLE for J5 and J6 (both A and B circuits)
- Step 4. Place a power supply on T1-T3 and T5-T7
- Step 5. Place loads between T2-T4 and T6-T8

5.2 Operation

To operate the EVM, use the following guidelines:

- Turn on the power supplies to 12 V.
- Ensure that the output voltage, VOUT, is approximately 12 V.
- Vary the load as necessary for test purposes.

5.3 Waveforms

Figure 16 shows a hot-short on load 1 which results in a shutdown of the first hot-swap gate.

NOTE: Note that the second load continues to be powered while both HGATE2 and VMIDDLE remain high.

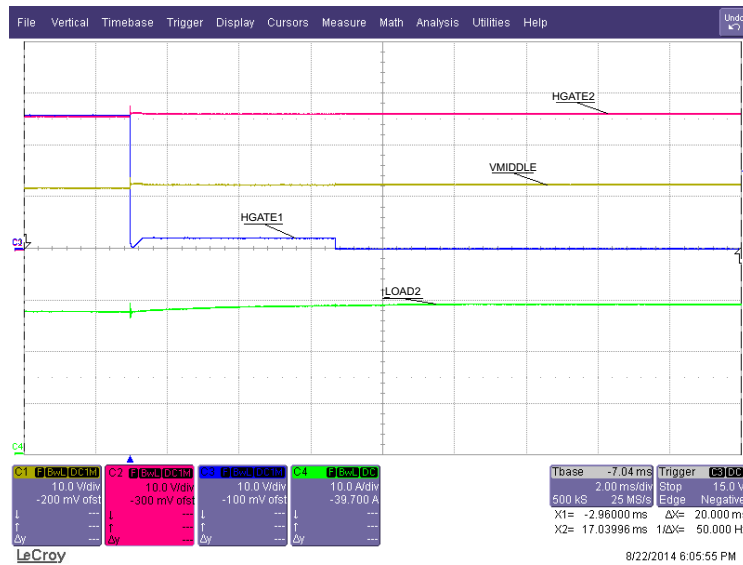


Figure 16. Hot Short on Load 1, Load 2 not Interrupted

The main purpose of the ORing controller is to protect the loads when one of the input supplies has a failure. The waveforms in Figure 17 and Figure 18 show this scenario. Figure 17 shows a condition where both of the power supplies are at the same voltage and both of the BGATES are ON. When VIN1 goes to ground, BGATE1 quickly turns OFF, while BGATE2 remains ON. In Figure 18, VIN1 is greater than VIN2 so the system starts with only BGATE1 ON. When VIN1 goes to ground, BGATE1 quickly turns off and BGATE2 turns ON. A short delay occurs between BGATE1 turning off and BGATE2 turning ON. This pause is because VMIDDLE discharges from 12.5 V to 12 V (BGATE2 only turns on when VIN2 > VMIDDLE)

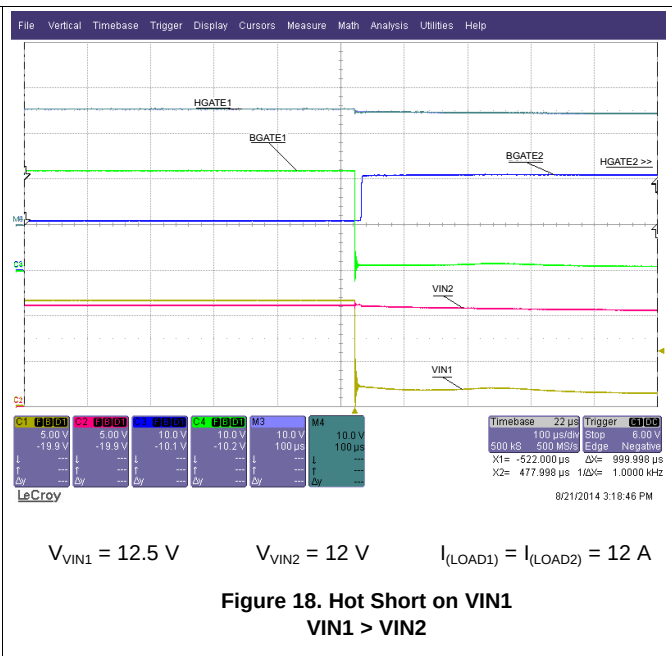
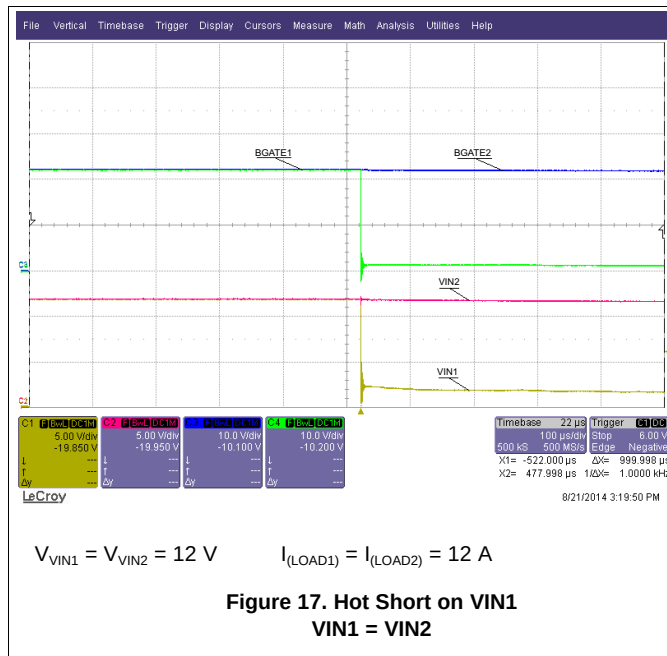
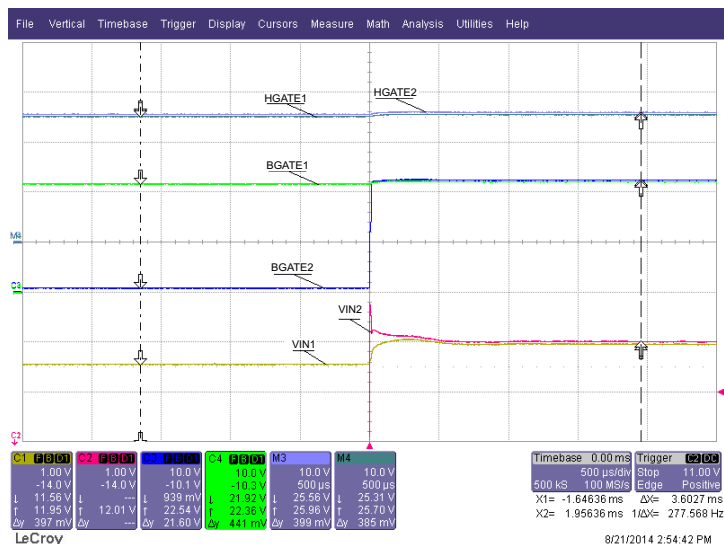


Figure 19 shows a system configuration where VIN1 equals VIN2 and VIN2 is hot plugged.

NOTE: When BGATE2 goes up, VIN1 rises almost immediately which is because VIN1 had some voltage droop because of the IR drop of the input impedance. When a second supply was placed in parallel the load was shared which reduced the droop. The quick input spike on VIN2 is because of input inductance.



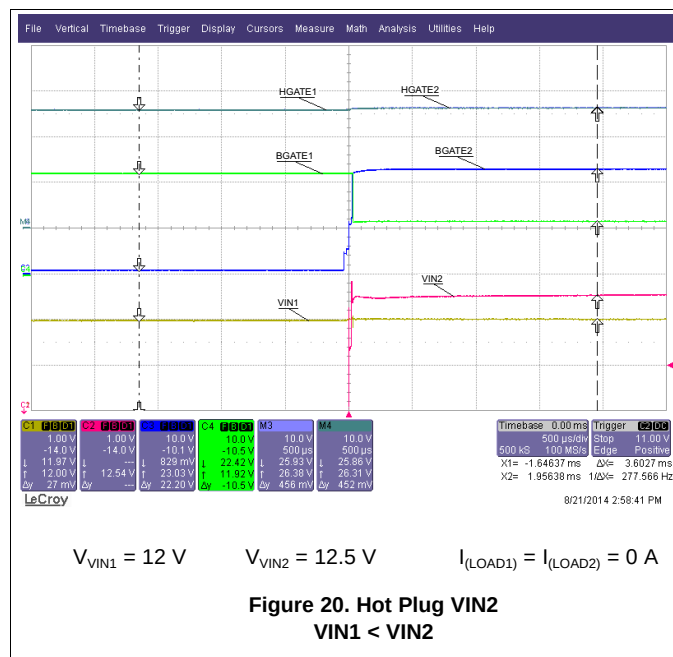
$$V_{VIN1} = 12 \text{ V}$$

$$V_{VIN2} = 12 \text{ V}$$

$$I_{(LOAD1)} = I_{(LOAD2)} = 12 \text{ A}$$

Figure 19. Hot Plug VIN2

Figure 20 and Figure 21 show the hot-plugging event when VIN1 does not equal VIN2. In Figure 20, VIN2 is greater than VIN1. Therefore, when VIN2 is hot-plugged, BGATE1 goes down and BGATE2 comes up. In Figure 21, VIN2 is less than VIN1. Therefore, when VIN is hot-plugged, BGATE2 does not turn on.

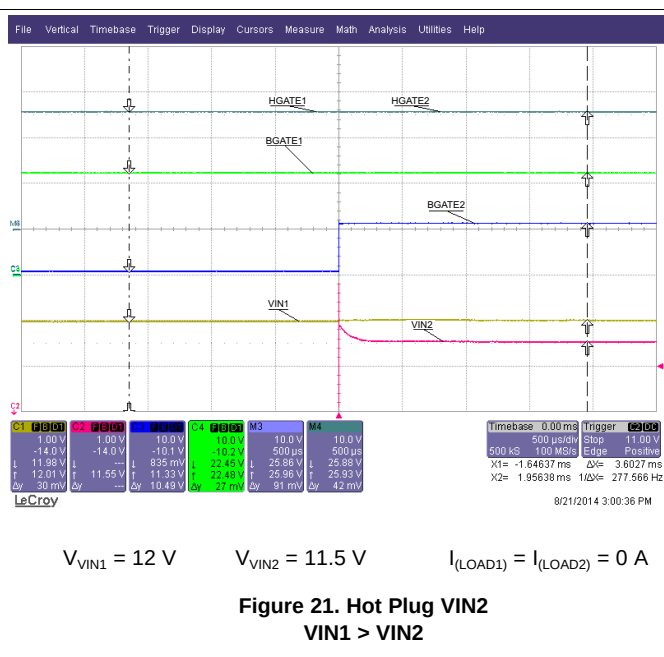


$$V_{VIN1} = 12 \text{ V}$$

$$V_{VIN2} = 12.5 \text{ V}$$

$$I_{(LOAD1)} = I_{(LOAD2)} = 0 \text{ A}$$

Figure 20. Hot Plug VIN2
VIN1 < VIN2



$$V_{VIN1} = 12 \text{ V}$$

$$V_{VIN2} = 11.5 \text{ V}$$

$$I_{(LOAD1)} = I_{(LOAD2)} = 0 \text{ A}$$

Figure 21. Hot Plug VIN2
VIN1 > VIN2

6 EVM Assembly Drawing and PCB Layout

6.1 PCB Drawings

Figure 22 through Figure 26 show the component placement and layout of the TPS24740EVM-596.

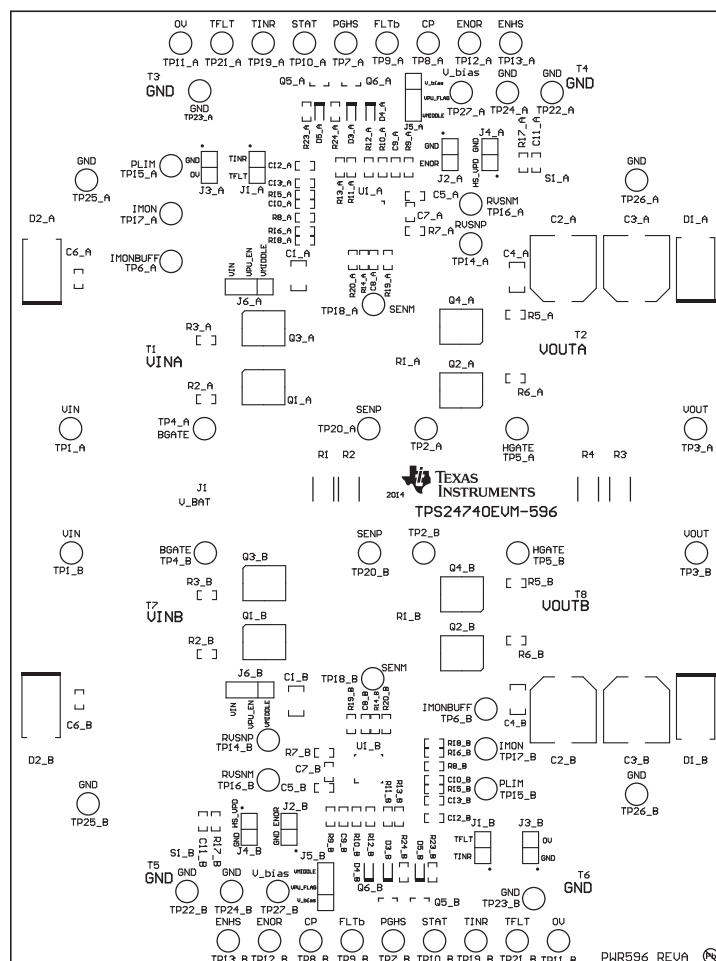


Figure 22. Top Side Component Placement

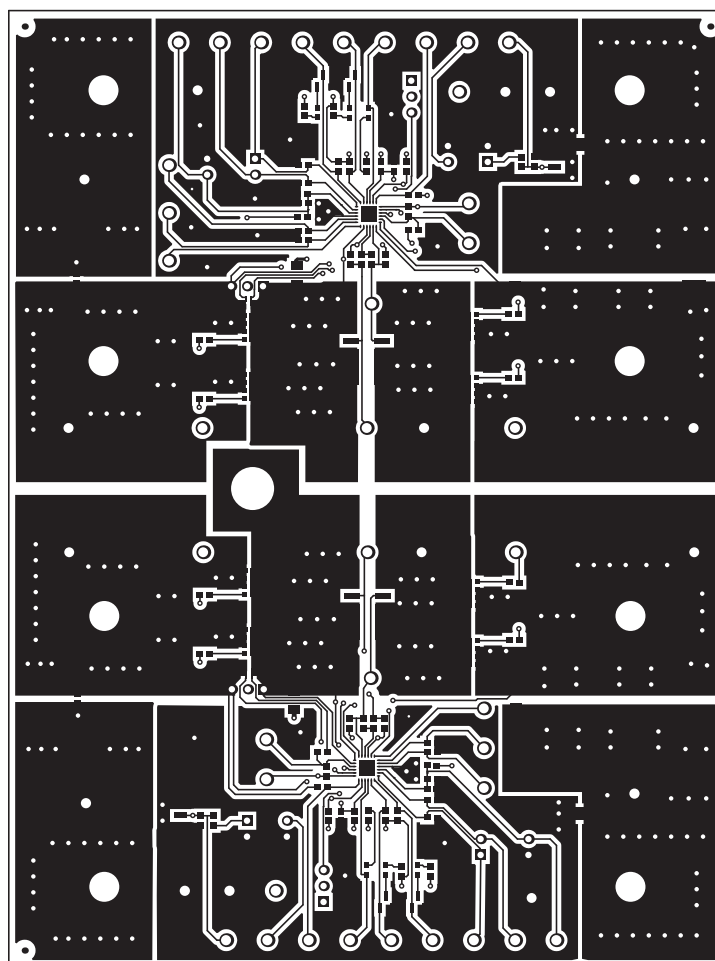


Figure 23. Top-Side Routing

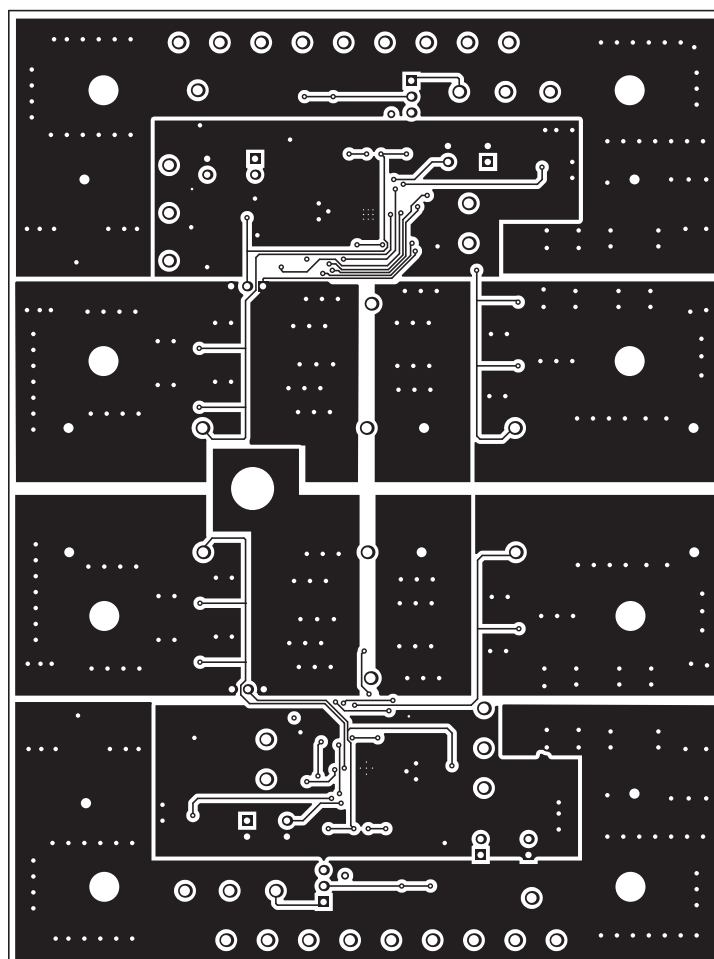


Figure 24. Midlayer 1 Routing

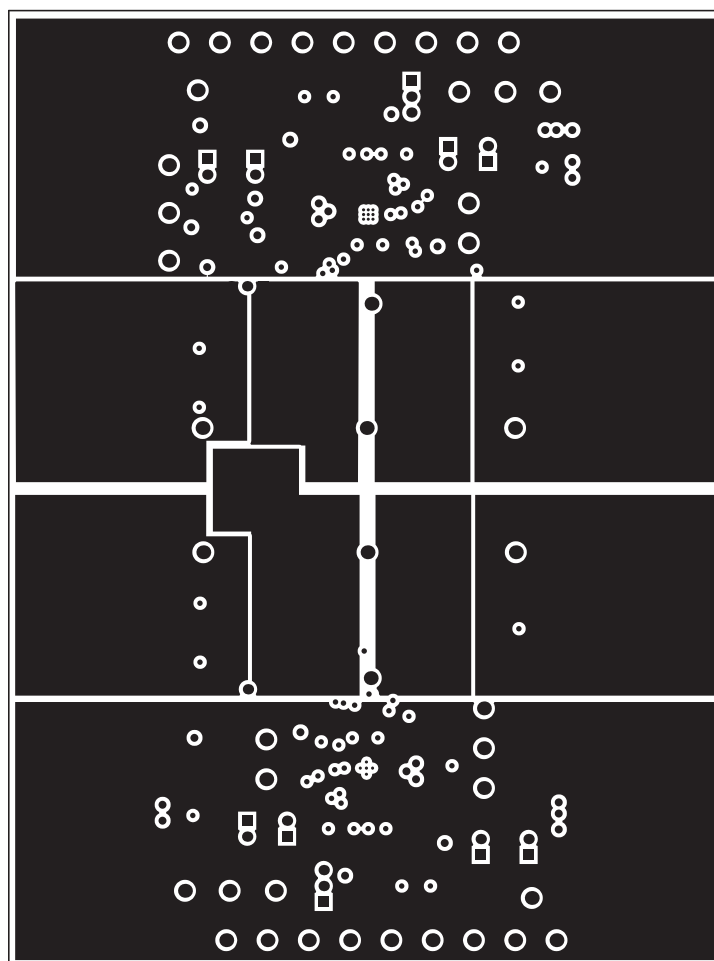


Figure 25. Midlayer 2 Routing

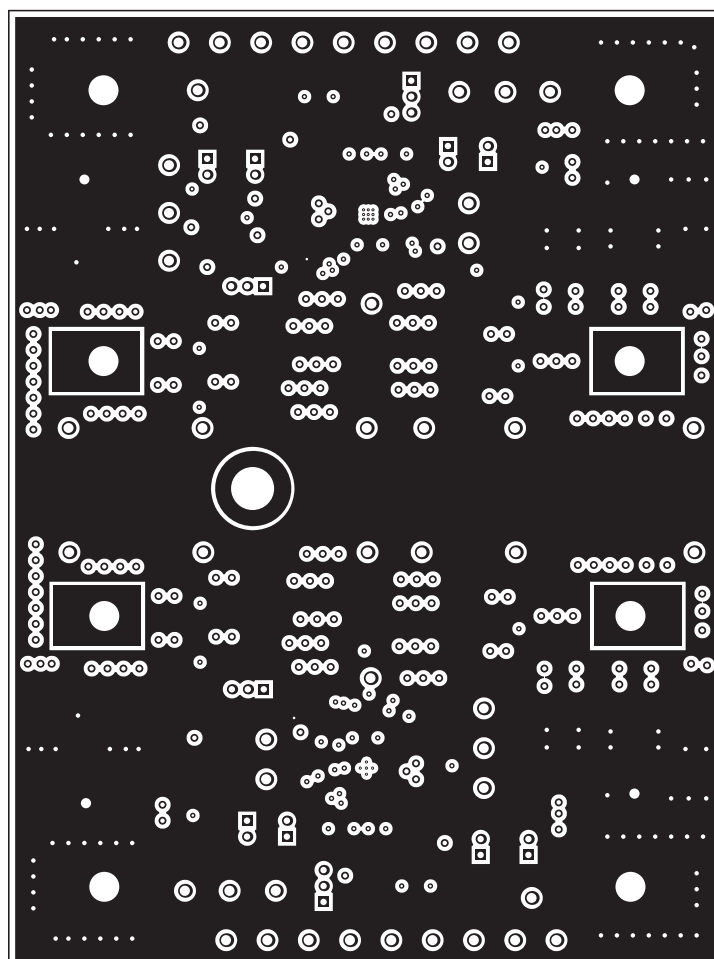


Figure 26. Bottom Layer Routing

7 Bill of Materials

Table 3. Table 3. TPS24740EVM-596 BOM

Designator	QTY	Value	Description	Package Reference	Part Number	MFR
C1_A, C1_B	2	0.1 μ F	Capacitor, ceramic, 0.1 μ F, 100 V, $\pm$ 10%, X7R, 1206	1206	12061C104KAT2A	AVX
C2_A, C2_B, C3_A, C3_B	4	220 μ F	Capacitor, AL, 220 μ F, 50 V, $\pm$ 20%, 0.3 Ω , SMD	SMT Radial G	EEE-FC1H221P	Panasonic
C4_A, C4_B	2	1 μ F	Capacitor, ceramic, 1 μ F, 100 V, $\pm$ 10%, X7R, 1206	1206	GRM31CR72A105KA01L	MuRata
C5_A, C5_B, C6_A, C6_B	4	0.1 μ F	Capacitor, ceramic, 0.1 μ F, 25 V, $\pm$ 5%, X7R, 0603	0603	06033C104JAT2A	AVX
C7_A, C7_B, C13_A, C13_B	4	0.033 μ F	Capacitor, ceramic, 0.033 μ F, 50 V, $\pm$ 10%, X7R, 0603	0603	GRM188R71H333KA61D	MuRata
C8_A, C8_B	2	2200pF	Capacitor, ceramic, 2200pF, 50 V, $\pm$ 10%, X7R, 0603	0603	C0603C222K5RAC	Kemet
D1_A, D1_B	2	0.5 V	Diode, Schottky, 30 V, 3 A, SMC	SMC	MBRS330T3G	ON Semiconductor
D2_A, D2_B	2	14 V	Diode, TVS, Uni, 14 V, 5000W, SMC	SMC	5.0SMDJ14A	Littelfuse
D3_A, D3_B	2	Green	LED, Green, SMD	1.6 $\times$ 0.8 $\times$ 0.8 mm	LTST-C190GKT	Lite-On
D4_A, D4_B	2	Red	LED, Red, SMD	Red LED, 1.6 $\times$ 0.8 $\times$ 0.8 mm	LTST-C190CKT	Lite-On
D5_A, D5_B	2	Orange	LED, Orange, SMD	1.6 $\times$ 0.8 $\times$ 0.8 mm	LTST-C190KFKT	Lite-On
Q3_A, Q3_B, Q4_A, Q4_B	4	CSD16415Q5	MOSFET, N-CH, 25 V, 100 A, SON 5 $\times$ 6 mm	SON 5 $\times$ 6 mm	CSD16415Q5	Texas Instruments
Q5_A, Q5_B, Q6_A, Q6_B	4	60 V	MOSFET, N-CH, 60V, 0.17A, SOT-23	SOT-23	2N7002-7-F	Diodes Inc.
R1_A, R1_B	2	0.0005 Ω	Resistor, 0.0005, 1%, 3 W, 6.6 $\times$ 3 $\times$ 6.9 mm	6.6 $\times$ 3 $\times$ 6.9 mm	WSL2726L5000FEB	Vishay-Dale
R2_A, R2_B, R3_A, R3_B, R5_A, R5_B, R6_A, R6_B	8	10 Ω	Resistor, 10 Ω , 1%, 0.1 W, 0603	0603	CRCW060310R0FKEA	Vishay-Dale
R7_A, R7_B	2	15 Ω	Resistor, 15 Ω , 1%, 0.1 W, 0603	0603	CRCW060315R0FKEA	Vishay-Dale
R8_A, R8_B, R9_A, R9_B, R10_A, R10_B	6	49.9 Ω	Resistor, 49.9 k Ω , 1%, 0.1 W, 0603	0603	CRCW060349K9FKEA	Vishay-Dale
R11_A, R11_B, R13_A, R13_B	4	100 k Ω	Resistor, 100 k Ω , 1%, 0.1 W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale
R12_A, R12_B, R23_A, R23_B, R24_A, R24_B	6	22 k Ω	Resistor, 22 k Ω , 1%, 0.1 W, 0603	0603	RC0603FR-0722KL	Yageo America
R14_A, R14_B	2	249 Ω	Resistor, 249 Ω , 1%, 0.1 W, 0603	0603	CRCW0603249RFKEA	Vishay-Dale
R15_A, R15_B	2	5.11 k Ω	Resistor, 5.11 k Ω , 1%, 0.1 W, 0603	0603	CRCW06035K11FKEA	Vishay-Dale
R16_A, R16_B	2	113 k Ω	Resistor, 113 k Ω , 1%, 0.1 W, 0603	0603	CRCW0603113KFKEA	Vishay-Dale
R17_A, R17_B	2	7.5 k Ω	Resistor, 7.5 k Ω , 5%, 0.1 W, 0603	0603	CRCW06037K50JNEA	Vishay-Dale
R18_A, R18_B	2	2.70 k Ω	Resistor, 2.7 k Ω , 0.1%, 0.1 W, 0603	0603	RG1608P-272-B-T5	Susumu Co Ltd

Table 3. Table 3. TPS24740EVM-596 BOM (continued)

Designator	QTY	Value	Description	Package Reference	Part Number	MFR
R20_A, R20_B	2	69.8 Ω	Resistor, 69.8 Ω , 0.1%, 0.1 W, 0603	0603	ERA-3AEB69R8V	Panasonic
S1_A, S1_B	2		Switch, Push Button, SMD	2.9 × 2 × 3.9 mm SMD	SKRKAEE010	Alps
U1_A, U1_B	2		2.5-V to 18-V Positive Voltage Hot-Swap and Oring Controller, RGE0024B	RGE0024B	TPS24740RGE	Texas Instruments
C9_A, C9_B, C10_A, C10_B, C11_A, C11_B	0	0.1 μ F	Capacitor, ceramic, 0.1 μ F, 16 V, $\pm$ 5%, X7R, 0603	0603	0603YC104JAT2A	AVX
C12_A, C12_B	0	0.1 μ F	Capacitor, ceramic, 0.1 μ F, 25 V, $\pm$ 5%, X7R, 0603	0603	06033C104JAT2A	AVX
Q1_A, Q1_B, Q2_A, Q2_B	0	DNP	MOSFET, N-CH, 25 V, 100 A, SON 5 × 6 mm	SON 5 × 6mm	CSD16415Q5	Texas Instruments
R1, R2, R3, R4	0	0.005 Ω	Resistor, 0.005 Ω , 1%, 2 W, 2512	2512	73M2R005F	CTS Resistor
R19_A, R19_B	0	1 k Ω	Resistor, 1 k Ω , 1%, 0.1 W, 0603	0603	CRCW06031K00FKEA	Vishay-Dale

8 Evaluation of the TPS24772 IC using the TPS23740EVM-596 PCB

The TPS24740EVM-596 PCB can be used to evaluate the TPS24772 hot-swap only performance. Simply use the V_BAT connector as the input voltage rail of the hotswap. The output connectors T2 and T4 will be the output of the hotswap.

8.1 TPS24772 Performance

Figure 27 through Figure 31 display the performance of the TPS24772.

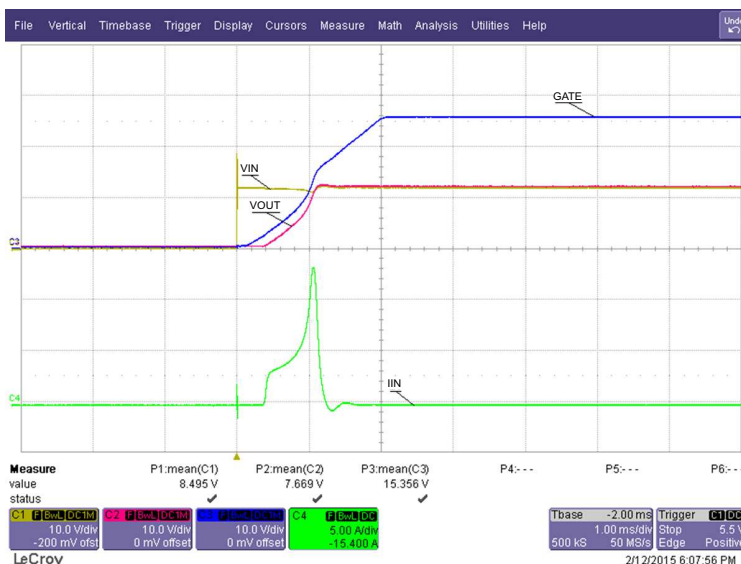


Figure 27. Startup

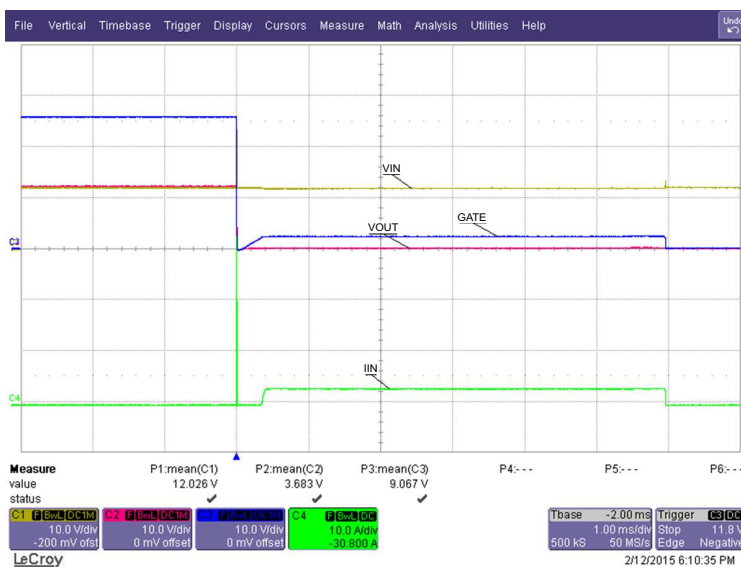


Figure 28. Hot Short on VOUT (Zoomed Out)

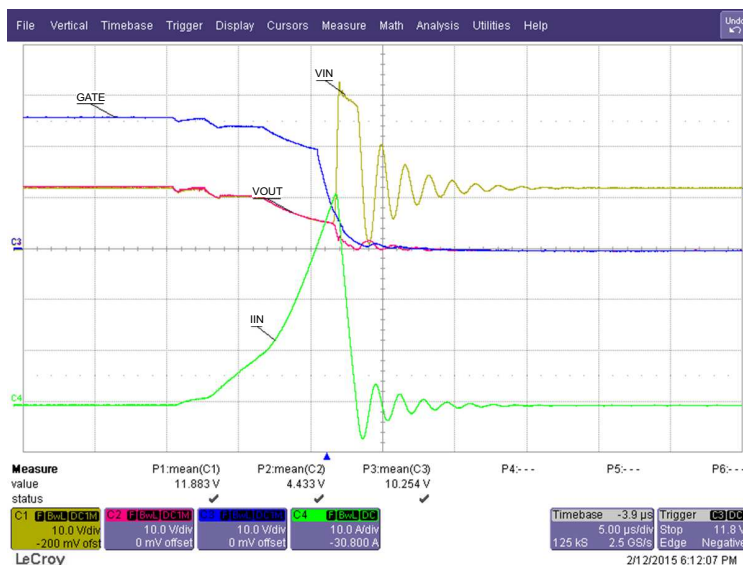


Figure 29. Hot Short on VOUT (Zoomed In)

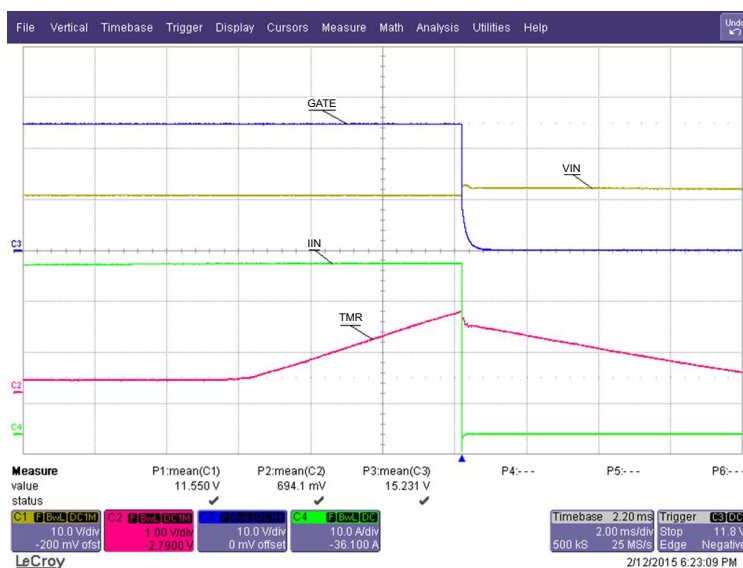


Figure 30. Overcurrent

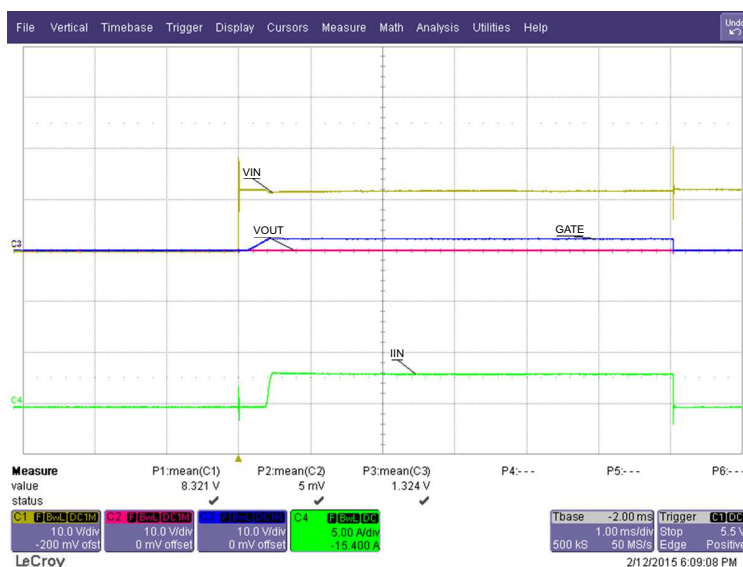


Figure 31. Startup Into Short

Revision History

Changes from Original (November 2014) to A Revision

Page

- Added new paragraph to the Introduction. 1
- Added Section 8 to this UG with 5 new graphics..... 19

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

STANDARD TERMS AND CONDITIONS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, or documentation (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms and conditions set forth herein. Acceptance of the EVM is expressly subject to the following terms and conditions.

- 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms and conditions that accompany such Software
- 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.

- 2 *Limited Warranty and Related Remedies/Disclaimers:*

- 2.1 These terms and conditions do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
- 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for any defects that are caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI. Moreover, TI shall not be liable for any defects that result from User's design, specifications or instructions for such EVMs. Testing and other quality control techniques are used to the extent TI deems necessary or as mandated by government requirements. TI does not test all parameters of each EVM.
- 2.3 If any EVM fails to conform to the warranty set forth above, TI's sole liability shall be at its option to repair or replace such EVM, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

- 3 *Regulatory Notices:*

- 3.1 *United States*

3.1.1 *Notice applicable to EVMs not FCC-Approved:*

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_01.page

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_02.page
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4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMS are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMS, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

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